30A, 100V, Very Low Forward Voltage Trench-Based Schottky Rectifier

Features

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing Diodes
- Reverse Battery Protection
- Instrumentation

Mechanical Characteristics

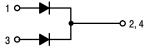
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec



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PIN CONNECTIONS





MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week AKA = Polarity Designator G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	100	٧
Average Rectified Forward Current (Rated V_R , T_C = 116°C) (Rated V_R , T_C = 136°C)	Per device Per diode	I _{F(AV)}	30 15	Α
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz, T_C = 109°C) (Rated V_R , Square Wave, 20 kHz, T_C = 133°C)	Per device Per diode	I _{FRM}	60 30	А
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I _{FSM}	125	А
Operating Junction Temperature		TJ	-40 to +175	°C
Storage Temperature		T _{stg}	-40 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Rating			Value	Unit
Typical Thermal Resistance	Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	1.4 47	°C/W °C/W

ELECTRICAL CHARACTERISTICS (Per Leg unless otherwise noted)

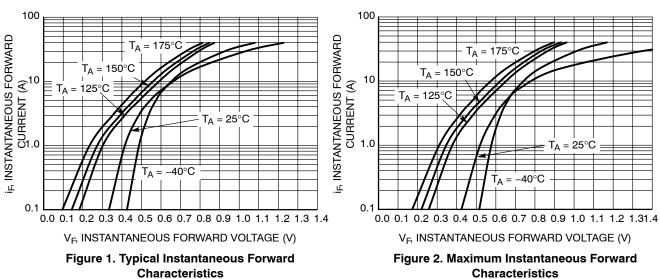
Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1)	VF	0.544 0.606 0.761	- - 0.9	V
$(I_F = 5 A, T_J = 125^{\circ}C)$ $(I_F = 7.5 A, T_J = 125^{\circ}C)$ $(I_F = 15 A, T_J = 125^{\circ}C)$		0.471 0.539 0.662	- - 0.73	
Maximum Instantaneous Reverse Current (Note 1) $ (V_R = 70 \text{ V}, T_J = 25^{\circ}\text{C}) $ $ (V_R = 70 \text{ V}, T_J = 125^{\circ}\text{C}) $	I _R	1.7 2.1		μA mA
(Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 125^{\circ}C$)		_ 5.0	85 16	μA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle $\leq 2.0\%$

ORDERING INFORMATION

Device	Package	Shipping
NTSV30H100ECTG	TO-220AB (Pb-Free)	50 Units / Rail

TYPICAL CHARACTERISTICS



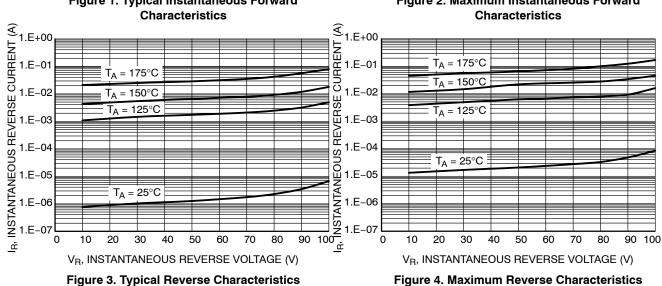


Figure 3. Typical Reverse Characteristics

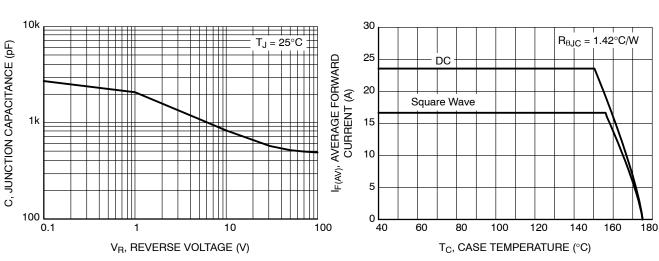


Figure 5. Typical Junction Capacitance

Figure 6. Current Derating per Leg

TYPICAL CHARACTERISTICS

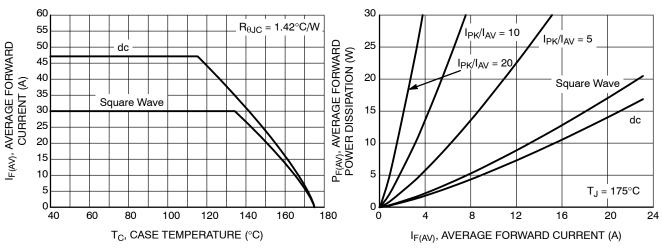


Figure 7. Current Derating per Leg

Figure 8. Forward Power Dissipation

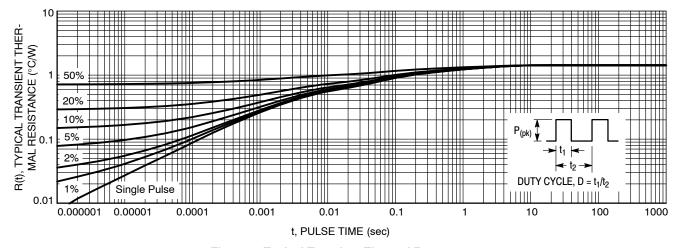
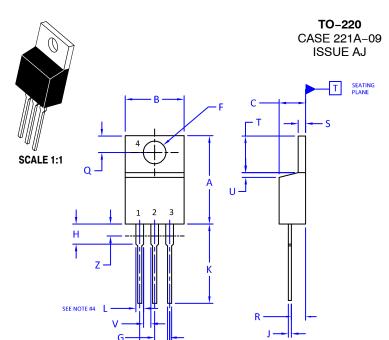


Figure 9. Typical Transient Thermal Response





DATE 05 NOV 2019

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMETERS	
DIM	MIN.	MAX.	MIN.	MAX.
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

	STYLE 2:		STYLE 3:		STYLE 4:	
BASE	PIN 1.	BASE	PIN 1.	CATHODE	PIN 1.	MAIN TERMINAL 1
COLLECTOR	2.	EMITTER	2.	ANODE	2.	MAIN TERMINAL 2
EMITTER	3.	COLLECTOR	3.	GATE	3.	GATE
COLLECTOR	4.	EMITTER	4.	ANODE	4.	MAIN TERMINAL 2
	STYLE 6:		STYLE 7:		STYLE 8:	
GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	CATHODE
DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE
SOURCE	3.	ANODE	3.	CATHODE	3.	EXTERNAL TRIP/DELA
DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE
	STYLE 10:		STYLE 11:		STYLE 12	:
GATE	PIN 1.	GATE	PIN 1.	DRAIN	PIN 1.	MAIN TERMINAL 1
COLLECTOR	2.	SOURCE	2.	SOURCE	2.	MAIN TERMINAL 2
EMITTER	3.	DRAIN	3.	GATE	3.	GATE
COLLECTOR	4.	SOURCE	4.	SOURCE	4.	NOT CONNECTED
	COLLECTOR EMITTER COLLECTOR GATE DRAIN SOURCE DRAIN GATE COLLECTOR EMITTER	BASE PIN 1. COLLECTOR 2. EMITTER 3. COLLECTOR 4. STYLE 6: PIN 1. GATE PIN 1. DRAIN 2. SOURCE 3. DRAIN 4. STYLE 10: GATE PIN 1. COLLECTOR 2. EMITTER 3.	BASE	BASE COLLECTOR PIN 1. 2. EMITTER BASE 2. EMITTER PIN 1. 2. EMITTER GOLLECTOR 3. COLLECTOR 3. COLLECTOR 4. EMITTER 4. STYLE 7: GATE STYLE 7: PIN 1. ANODE PIN 1. PIN 1. GATE STYLE 11: PIN 1. PIN	BASE	BASE

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